



1Mx32 FLASH MODULE

DESCRIPTION

The EDI7F341MC and EDI7F2341MC are organized as one and two banks of 1Mx32 respectively. The modules are based on Intel's E28F008SA - 1Mx8 Flash device in TSOP packages which are mounted on an FR4 substrate.

Both modules offer access times between 90 and 150ns allowing for operation of high-speed microprocessors without wait states.

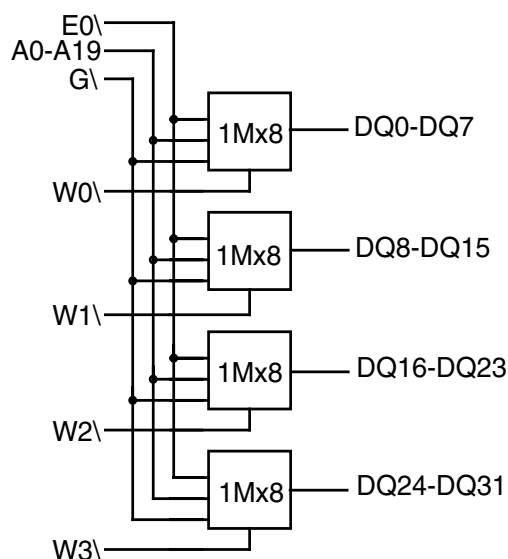
FEATURES

- 1Mx32 and 2x1Mx32 Densities
- Based on Intel's E28F008SA Flash Device
- Fast Read Access Time - 90ns
- 5- Volt-Only Reprogramming or 12V Reprogram.
- Low Power Dissipation
 - 60mA per Device Active Current
 - 10µA per Device CMOS Standby Current
- Typical Endurance >100,000 Cycles
- Single 5 Volt $\pm 10\%$ Supply
- CMOS and TTL Compatible Inputs and Outputs
- Commercial and Industrial Temperature Range
- Package
 - 80 Pin SIMM (JEDEC)

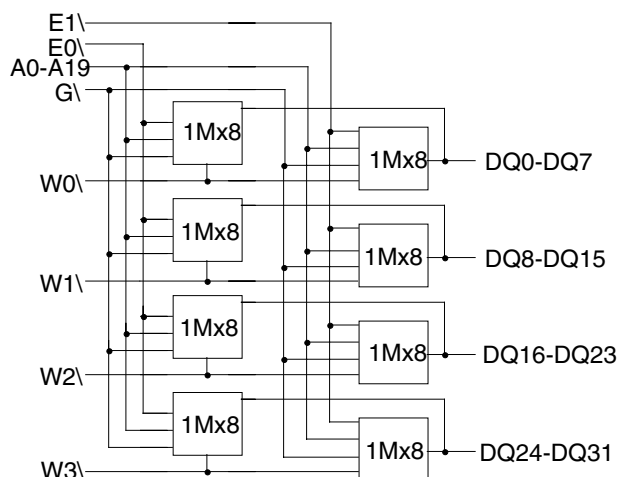
FIG. 1

BLOCK DIAGRAMS

EDI7F341MC-BNC: 1Mx32 80 PIN SIMM



EDI7F2341MC-BNC: 2x1Mx32 80 PIN SIMM





CAPACITANCE

(f=1.0MHz, VIN = VCC or VSS)

Parameter	Sym	1Meg	2x1Meg	Unit
		Max	Max	
Address Lines	CA	35	70	pF
Data lines	CDQ	15	30	pF
Chip & Write Enable Lines	CC	15	30	pF
Output Enable lines	CG	35	70	pF

PIN CONFIGURATIONS

Pin #	Pin Name	Pin #	Pin Name	Pin #	Pin Name	Pin #	Pin Name
1	VSS	21	*	41	A11	61	DQ9
2	VCC	22	*	42	A10	62	DQ8
3	VPP	23	*	43	A9	63	DQ7
4	G\	24	*	44	A8	64	DQ6
5	W0\	25	VSS	45	A7	65	DQ5
6	W1\	26	DQ29	46	A6	66	DQ4
7	NC	27	DQ30	47	A5	67	DQ3
8	DQ16	28	DQ31	48	A4	68	DQ2
9	DQ17	29	W2\	49	A3	69	DQ1
10	DQ18	30	NC	50	A2	70	DQ0
11	DQ19	31	NC	51	A1	71	VPP
12	DQ20	32	NC	52	AO	72	VCC
13	DQ21	33	A19	53	W3\	73	PD1
14	DQ22	34	A18	54	VSS	74	PD2
15	DQ23	35	A17	55	DQ15	75	PD3
16	DQ24	36	A16	56	DQ14	76	PD4
17	DQ25	37	A15	57	DQ13	77	PD5
18	DQ26	38	A14	58	DQ12	78	PD6
19	DQ27	39	A13	59	DQ11	79	PD7
20	DQ28	40	A12	60	DQ10	80	VSS

*TBD

Simm Density		
Pin	1Meg	2x1Meg
21	NC	NC
22	NC	NC
23	NC	E1\
24	E0\	E0\

Presence Detect Pin Out		
Pin	1Meg	2x1Meg
PD1	NC	VSS
PD2	VSS	VSS
PD3	NC	NC
PD4	VSS	VSS

A0-A19 Address input
 E0\,E1\ Chip Enable
 W0\-W3\ Write Enable
 G\ Output Enable
 DQ0-DQ31 Data Input/Output
 PD Presence Detect
 VCC Power 5 V $\pm 10\%$
 VSS Ground
 NC No Connect

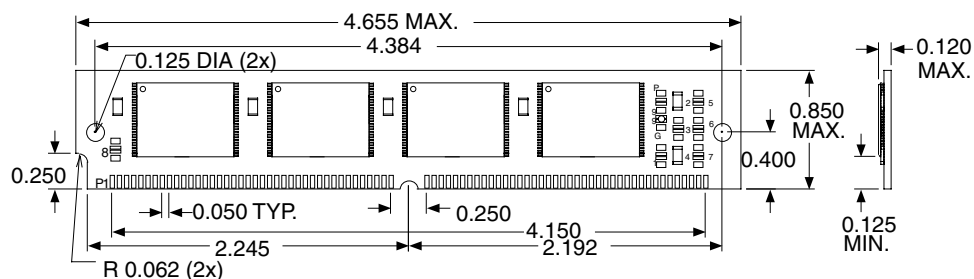


ORDERING INFORMATION

Part Number	Speed (ns)	Package No.
EDI7F341MC90BNC	90	362
EDI7F341MC100BNC	100	362
EDI7F341MC120BNC	120	362
EDI7F341MC150BNC	150	362

Note: For gold contact option, change EDI7F to EDI7G.

PACKAGE NO. 362: 80 PIN SIMM (JEDEC)

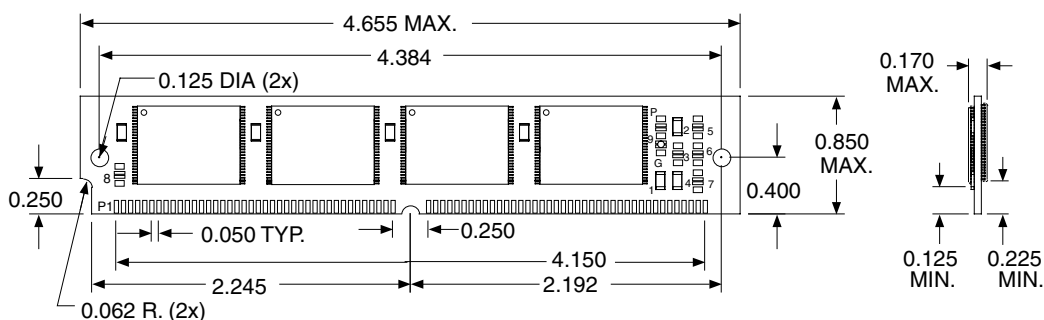


ORDERING INFORMATION

Part Number	Speed (ns)	Package No.
EDI7F2341MC90BNC	90	363
EDI7F2341MC100BNC	100	363
EDI7F2341MC120BNC	120	363
EDI7F2341MC150BNC	150	363

Note: For gold contact option, change EDI7F to EDI7G.

PACKAGE NO. 363: 80 PIN SIMM (JEDEC)



ALL DIMENSIONS ARE IN INCHES

DATASHEET APPROVALS

EDI PART NO. EDI7F341MC ECO# 15633
NEW REV 2A DATE 10/1/02

<u>APPROVAL:</u>	<u>INITIAL</u>	<u>DATE</u>	<u>CORRECTION ON PAGES</u>
JUAN GUZMAN L.K.	_____	_____	_____
MUKESH TRIVEDI M.A.	_____	_____	_____
PAUL MARIEN	_____	_____	_____
LARRY WINROTH	_____	_____	_____
DAVE KELLY	_____	_____	_____
MARK DOWNEY	_____	_____	_____
DAVE HARRISON	_____	_____	_____
TONY LEE	_____	_____	_____
BOB KHEDERIAN	_____	_____	_____
LUIS ESTELLA	_____	_____	_____

WILL THIS DATASHEET GO ON THE WEB? YES NO LINE: _____
FAMILY: _____

IS THIS A NEW DATASHEET? PROD.TYPE: _____
ORG: _____
DENSITY: _____
SPEED: _____
PKG: _____
VOLTAGE: _____

WILL THIS DATASHEET REPLACE AN EXISTING
DATASHEET THAT'S ALREADY ON THE WEB?

IF YES, WHAT DATASHEET IS IT REPLACING?

WHAT SECTION SHOULD THIS DATASHEET BE
PLACED IN ON THE WEB? _____

AFTER REVIEWING OR MAKING CORRECTIONS ON THE DATASHEET (S)
**PLEASE SIGN-OFF ON THIS SHEET AND ,MAKE YOUR CORRECTIONS –ON
THE ORIGINAL COPY(S).**

AFTER REVIEWING THE DATA SHEET, TEST ENGINEERING WILL COMPLETE THE SECTION BELOW.

TEST PROGRAM CHANGE REQUIRED:
YES: _____ NO _____ DATE: _____

TEST ENGINEER SIGNATURE _____

IF YES, DO NOT RELEASE DATA SHEET UNTIL TEST PROGRAM CHANGE IS COMPLETED.

TEST PROGRAM CHANGE COMPLETION DATE: _____
TEST PROGRAM NAME AND REVISION _____
TEST ENGINEER SIGNATURE _____